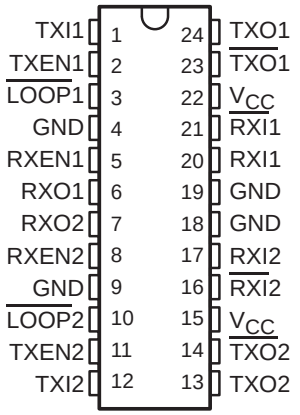
SN75ALS085
LAN ACCESS UNIT INTERFACE DUAL DRIVER/RECEIVER

SLLS054B – APRIL 1989 – REVISED MAY 1995

- **Meets or Exceeds the Requirements of IOS 8802.3:1989 and ANSI/IEEE Std 802.3-1988**
- **Interdevice Loop-Back Paths for System Testing**
- **Squelch Function Implemented on the Receiver Inputs**
- **Drivers Will Drive a Balanced 78-Ω Load**
- **Transformer Coupling Not Required in System**
- **Power-Up/Power-Down Protection (Glitch Free)**
- **Isolated Ground Pins for Reduced Noise Coupling**
- **Fault-Condition Protection Built into the Device**
- **Driver Inputs Are Level-Shifted ECL Compatible**

DW OR NT PACKAGE
(TOP VIEW)



description

The SN75ALS085 is a monolithic, high-speed, advanced low-power Schottky, dual-channel driver/receiver device designed for use in the AUI of ANSI/IEEE Std 802.3-1988. The two drivers on the device drive a 78-Ω balanced, terminated twisted-pair transmission line up to a maximum length of 50 meters. In the off (idle) state, the drivers maintain minimal differential output voltage on the twisted-pair line and, at the same time, remain within the required output common-mode range.

With the driver enable (TXEN) high, upon receiving the first falling edge into the driver input, the differential outputs will rise to full-amplitude output levels within 25 ns. The output amplitude is maintained for the remainder of the packet. After the last positive packet edge is transmitted into the driver, the driver will maintain a minimum of 70% full differential output for a minimum of 200 ns, then decay to a minimum level for the reset (idle) condition within 8 μs. Disabling the driver by taking the driver enable low will also force the output into the idle condition after the normal 8-μs timeout. While operating, the drivers are able to withstand a set of fault conditions and not suffer damage due to the faults being applied. The drivers power up in the idle state to ensure that no activity is placed on the twisted-pair cable that could be interpreted as network traffic.

The line receiver squelch function interfaces to a differential twisted-pair line terminated external to the device. The receiver squelch circuit allows differential receive signals to pass through as long as the input amplitude and pulse duration are greater than the minimum squelch threshold. This ensures a good signal-to-noise ratio while the data path is active and prevents system noise from causing false data transitions during line shutdown and line-idle conditions. The RXO outputs default to a high level and the RXEN outputs default to a low level while the squelch function is blocking the data path through the receiver (idle). The line receiver squelch will become active within 50 ns when the input squelch threshold is exceeded. RXEN will be driven high when the squelch circuit is allowing data to pass through the receiver. The receiver squelch circuit can also withstand a set of fault conditions while operating without causing permanent damage to the device.

description (continued)

The purpose of the loop functions is to provide a means by which system data path verification can be done to isolate faulty interfaces and assist in network diagnosis. The LOOP pins are TTL compatible and must be held high for normal operation. When $\overline{\text{LOOP1}}$ is taken low, the output of driver 1 (TXO1) immediately goes into the idle state. Also, the input to receiver 1 is ignored and a path from TXI1 to RXO1 is established. When $\overline{\text{LOOP1}}$ is taken back high, driver 1 and receiver 1 revert back to their normal operation. When $\overline{\text{LOOP2}}$ is taken low, a similar data path is established between TXI1 and RXO2. TXEN1 must be high for the loop functions to operate and TXEN1 can be used to gate the loop function if desired. During loop operation, the respective receiver enable output (RXEN) will reflect the status of TXEN1.

Function Tables

RECEIVER – $\overline{\text{LOOP}}$ = H

			OUTPUTS	
RXI		**PREVIOUS RXEN**	**RXEN**	**RXO**
V_{ID} = 1315 mV to –175 mV,	t_W < 25 ns	L	L	H
V_{ID} = –275 mV to –1315 mV,	t_W > 50 ns	X	H	L
V_{ID} = 318 mV to 1315 mV,	t_W < 142 ns	H	H	H
V_{ID} = 318 mV to 1315 mV,	t_W > 187 ns	X	L	H

H = high level, L = low level, X = don't care

DRIVER – $\overline{\text{LOOP}}$ = H

TXI	TXEN	PREVIOUS TXO	OUTPUT TXO
L	L	Idle	Idle
H	L	Idle	Idle
↓	H	Idle	L
L	H	Active	L
H < 260 μs	H	Active	H
H > 8 μs	H	Active	Idle
L	L > 8 μs	Active	Idle
H < 260 ns	L > 8 μs	Active	Idle
H < 260 ns	L < 260 ns	Active	H
H > 8 μs	L < 260 ns	Active	Idle
L	L < 260 ns	Active	L

H = $V_I \geq V_T$ max, L = $V_I \leq V_T$ min

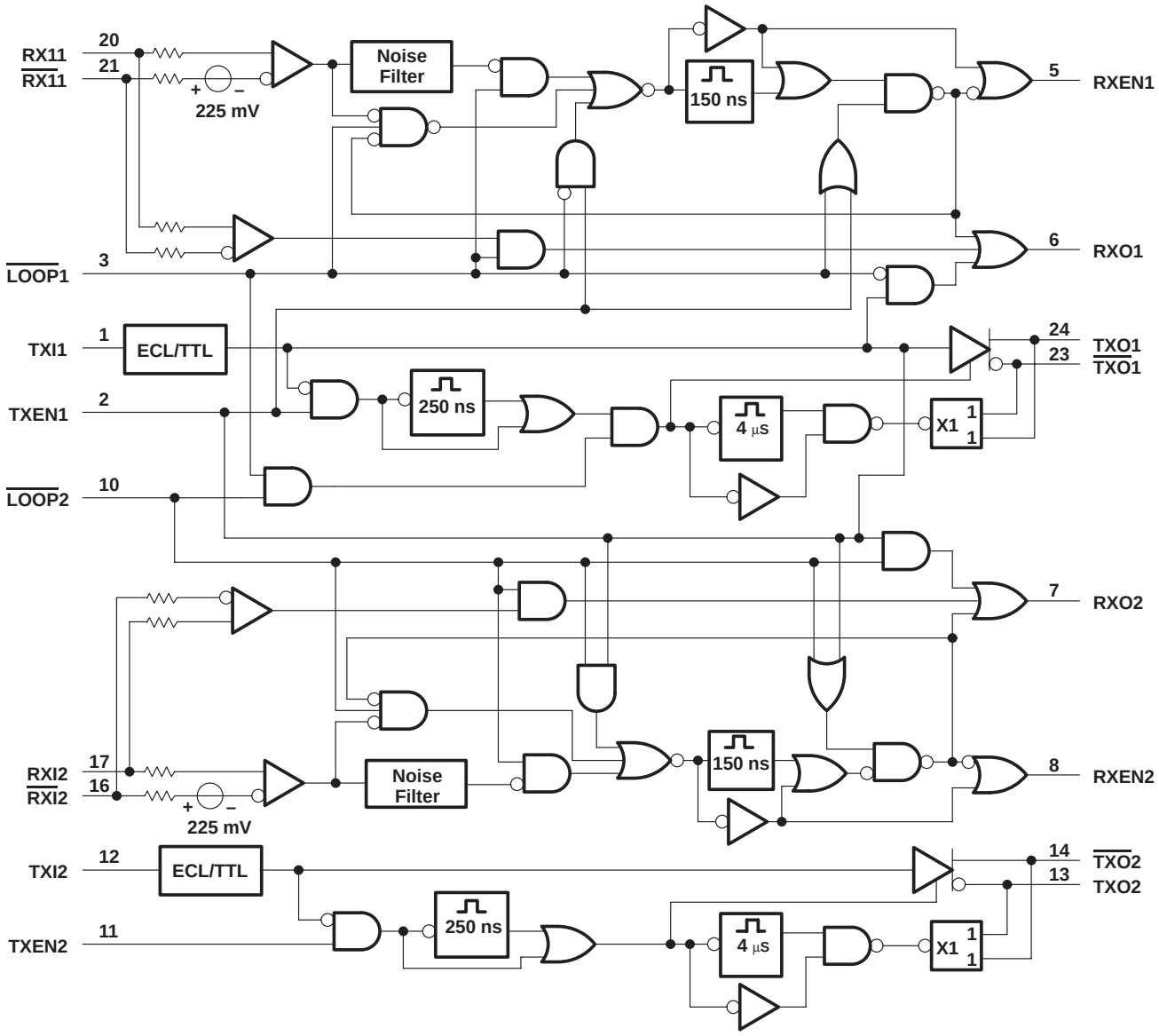
Function Tables (continued)

LOOP

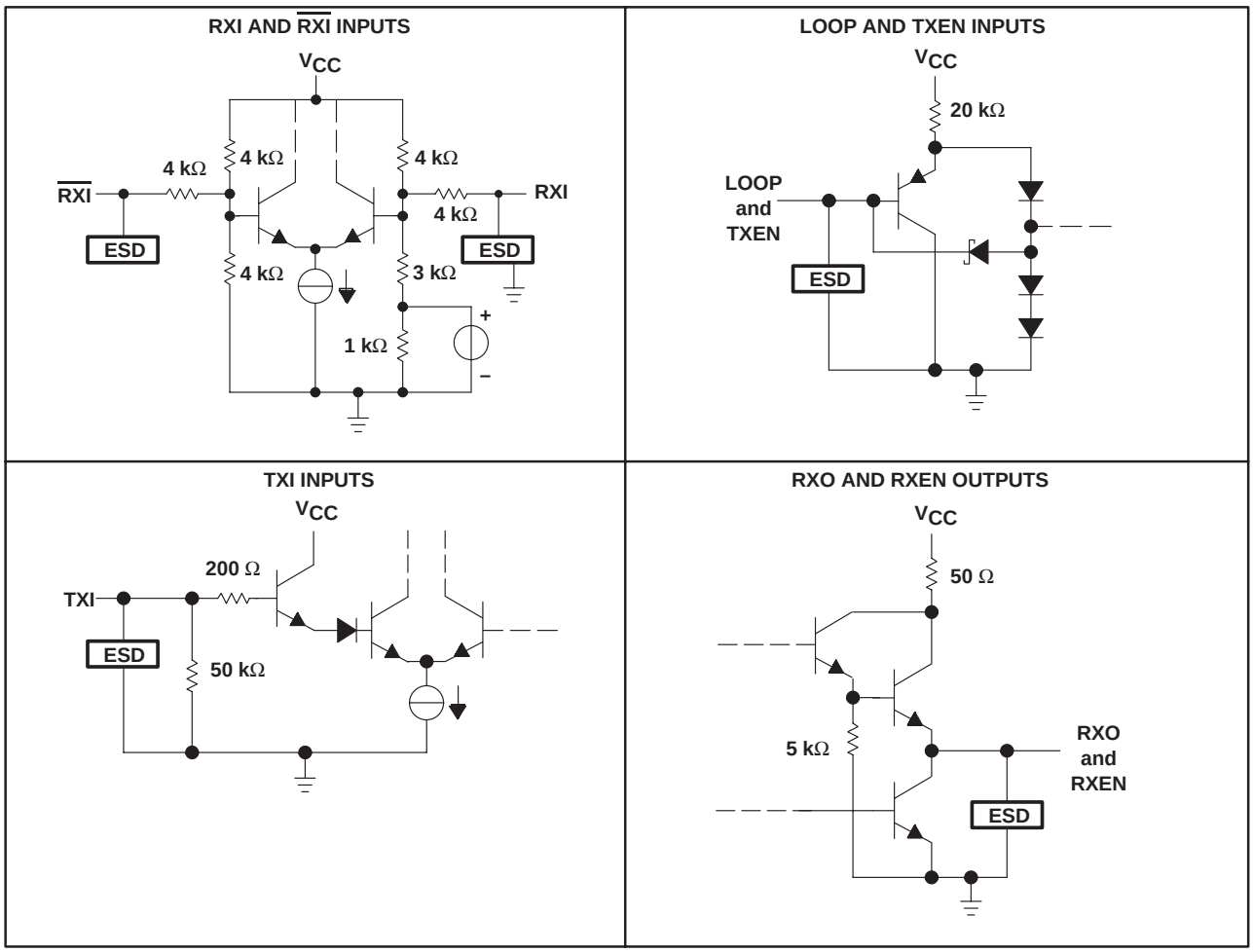
INPUTS						OUTPUTS				
$\overline{\text{LOOP1}}$	$\overline{\text{LOOP2}}$	TXI1	TXEN1	RXI1	RXI2	RXO1	RXO2	RXEN1	RXEN2	TXO1
L	L	L	H	X	X	L	L	H	H	Idle
L	L	H	H	X	X	H	H	H	H	Idle
L	L	X	L	X	X	H	H	L	L	Idle
L	H	L	H	X	Normal	L	Normal	H	Normal	Idle
L	H	H	H	X	Normal	H	Normal	H	Normal	Idle
L	H	X	L	X	Normal	H	Normal	L	Normal	Idle
H	L	L	H	Normal	X	Normal	L	Normal	H	Idle
H	L	H	H	Normal	X	Normal	H	Normal	H	Idle
H	L	X	L	Normal	X	Normal	H	Normal	L	Idle
H	H	Normal	Normal	Normal	Normal	Normal	Normal	Normal	Normal	Normal

H = high level, L = low level, X = don't care

logic diagram (positive logic)



schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 6 V
TXI and $\overline{\text{LOOP}}$ input voltage, V_I . . . . . 5.5 V
TXO and $\overline{\text{TXO}}$ output voltage, V_O . . . . . 16 V
RXI and $\overline{\text{RXI}}$ input voltage, V_I . . . . . 16 V
RXO and RXEN output voltage, V_O . . . . . 5.5 V
Continuous total power dissipation . . . . . See Dissipation Rating Table
Operating free-air temperature range, T_A . . . . . 0°C to 70°C
Storage temperature range, T_{stg} . . . . . – 65 °C to 150 °C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds . . . . . 260°C

NOTE 1: Voltage values are with respect to network ground terminal.

DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25°C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25°C$	$T_A = 70°C$ POWER RATING
DW	1350 mW	10.8 mW/°C	864 mW
NT	1250 mW	10.0 mW/°C	800 mW

recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}	4.75	5	5.25	V
Common-mode voltage at RXI inputs, V_{IC}	1		4.2	V
Differential voltage between RXI inputs, V_{ID}	±318		±1315	mV
High-level input voltage, $\overline{\text{LOOP}}$ and TXEN, V_{IH}	2			V
Low-level input voltage, $\overline{\text{LOOP}}$ and TXEN, V_{IL}			0.8	V
High-level output current, RXO and RXEN, I_{OH}			– 0.4	mA
Low-level output voltage, RXO and RXEN, I_{OL}			16	mA
Setup time, driver mode, TXEN high before TXI↓, t_{su1} (see Figure 7)	10			ns
Setup time, loop mode, $\overline{\text{LOOP}}$ low before TXEN↑, t_{su2} (see Figure 9)	15			ns
Setup time, loop mode, TXEN high before TXI↓, t_{su3} (see Figure 9)	10			ns
Hold time, loop mode, TXEN high after TXI↑, t_{h1} (see Figure 8)	10			ns
Hold time, loop mode, $\overline{\text{LOOP}}$ low after TXEN↓, t_{h2} (see Figure 8)	15			ns
Operating free-air temperature, T_A	0		70	°C

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER			TEST CONDITIONS		MIN	MAX	UNIT
V_{IK}	Clamp voltage at all inputs		I_I = –18 mA			–1.5	V
$V_{(TO)}$	Driver input (TXI) threshold voltage		T_A = 0°C	V_{CC} = 4.75 V	3.202	3.752	V
				V_{CC} = 5 V	3.389	3.998	
				V_{CC} = 5.25 V	3.577	4.244	
			T_A = 25°C	V_{CC} = 4.75 V	3.213	3.797	V
				V_{CC} = 5 V	3.400	4.043	
				V_{CC} = 5.25 V	3.588	4.289	
			T_A = 70°C	V_{CC} = 4.75 V	3.239	3.849	V
				V_{CC} = 5 V	3.426	4.095	
				V_{CC} = 5.25 V	3.614	4.341	
	Receiver differential input threshold voltage					–275	mV
V_{OC}	Driver output (TXO) common-mode voltage	Idle	$\overline{TXEN}$ at 0.8 V, $\overline{LOOP}$2 at 2 V,	$\overline{LOOP}$1 at 2 V, See Figure 1	1	4.2	V
		Active	$\overline{TXEN}$ at 2 V, $\overline{LOOP}$2 at 2 V, See Figure 1	$\overline{LOOP}$1 at 2 V, TXI at 3.2 V,	1	4.2	
		Active	$\overline{TXEN}$ at 2 V, $\overline{LOOP}$2 at 2 V, See Figure 1	$\overline{LOOP}$1 at 2 V, TXI at 4.4 V,	1	4.2	
V_{OD}	Driver output (TXO) differential voltage	Idle	$\overline{TXEN}$ at 0.8 V, $\overline{LOOP}$2 at 2 V,	$\overline{LOOP}$1 at 2 V, See Figure 1		±40	mV
		Active	$\overline{TXEN}$ at 2 V, $\overline{LOOP}$2 at 2 V, See Figure 1	$\overline{LOOP}$1 at 2 V, TXI at 3.2 V,	– 600	1315	
		Active	$\overline{TXEN}$ at 2 V, $\overline{LOOP}$2 at 2 V, See Figure 1	$\overline{LOOP}$1 at 2 V, TXI at 4.4 V,	600	1315	
V_{OH}	High-level output voltage	RXO, RXEN	I_{OH} = –0.4 mA		2.4		V
V_{OL}	Low-level output voltage	RXO, RXEN	I_{OL} = 16 mA			0.5	V
I_{IH}	High-level input current	TXEN, $\overline{LOOP}$	V_I = 2 V			20	µA
		TXI	V_I = 4.5 V			400	
		$\overline{RXI}$, RXI	V_{ID} = –0.5 V,	V_{IC} = 1 V to 4.2 V		1000	
I_{IL}	Low-level input current	TXEN, $\overline{LOOP}$	V_I = 0.8 V			–200	mA
		TXI	V_I = 3.1 V			100	
			V_I = 0.3 V		4	10	
		$\overline{RXI}$, RXI	V_{ID} = 0.5 V,	V_{IC} = 1 V to 4.2 V		1000	
I_{OD}	Driver differential output current	Idle	$\overline{TXEN}$ at 0.8 V, $\overline{LOOP}$2 at 2 V,	$\overline{LOOP}$1 at 2 V, See Figure 2		±4	mA
I_{OS}	Short-circuit output current†	RXO, RXEN	V_O at 0 V, RXI at 2 V	$\overline{RXI}$ at 3 V,	– 40	– 150	mA
I_{CC}	Supply current		$\overline{LOOP}$2 at 2 V, TXI at 4.5 V,	TXEN at 2 V, Outputs open		225	mA

† Not more than one output should be shorted at a time, and the duration of the test should not exceed 1 second.

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (continued)

PARAMETER	TEST CONDITIONS†			MIN	MAX	UNIT
Driver fault condition current	TXO shorted to $\overline{\text{TXO}}$,	Current measured in short			150	mA
	TXO at 0 V,	$\overline{\text{TXO}}$ is open,	Current measured at TXO		150	
	TXO is open,	$\overline{\text{TXO}}$ at 0,	Current measured at $\overline{\text{TXO}}$		150	
	TXO at 0 V,	$\overline{\text{TXO}}$ at 0 V,	Current measured at TXO and $\overline{\text{TXO}}$		150	
	TXO at 16 V,	$\overline{\text{TXO}}$ is open,	Current measured at TXO		150	
	TXO is open,	$\overline{\text{TXO}}$ at 16 V,	Current measured at TXO		150	
	TXO at 16 V,	$\overline{\text{TXO}}$ at 16 V,	Current measured at TXO and $\overline{\text{TXO}}$		150	
Receiver fault condition current	RXI shorted to $\overline{\text{RXI}}$,	Current measured in short			10	mA
	RXI at 0 V,	$\overline{\text{RXI}}$ is open,	Current measured at RXI		3	
	RXI is open,	$\overline{\text{RXI}}$ at 0 V,	Current measured at RXI		3	
	RXI at 0 V,	$\overline{\text{RXI}}$ at 0 V,	Current measured at RXI and $\overline{\text{RXI}}$		3	
	RXI at 16 V,	$\overline{\text{RXI}}$ at open,	Current measured at RXI		10	
	RXI at open,	$\overline{\text{RXI}}$ at 16 V,	Current measured at $\overline{\text{RXI}}$		10	
	RXI at 16 V,	$\overline{\text{RXI}}$ at 16 V,	Current measured at RXI and $\overline{\text{RXI}}$		10	

† Fault conditions should be measured on only one channel at a time.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

driver

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high level output	TXI	TXO, $\overline{\text{TXO}}$	TXEN at 2 V, See Figure 3		15	ns
t_{PHL}	Propagation delay time, high-to-low level output	TXI	TXO, $\overline{\text{TXO}}$	TXEN at 2 V, See Figure 3		15	ns
t_{PIL}	Propagation delay time, idle-to-low level output	TXI	TXO, $\overline{\text{TXO}}$	TXEN at 2 V, See Figure 4		25	ns
t_{PIL}	Propagation delay time, idle-to-low level output	TXEN	TXO, $\overline{\text{TXO}}$	TXI at 3.2 V, See Figure 5		25	ns
t_w	Output pulse duration from low-to-high level to 70% output level		TXO, $\overline{\text{TXO}}$	TXEN at 2 V, See Figure 6	260	8000	ns
$V_{OD(U)}$	Driver output differential undershoot voltage	TXI	TXO, $\overline{\text{TXO}}$	TXEN at 2 V, See Figure 6		–100	mV
t_{sk}	Driver caused signal skew $t_{PLH} - t_{PHL}$	TXI	TXO, $\overline{\text{TXO}}$	TXEN at 2 V, See Figure 3		±3	ns
t_r	Rise time, TXO, $\overline{\text{TXO}}$			TXEN at 2 V, See Figure 3	1	5	ns
t_f	Fall time, TXO, $\overline{\text{TXO}}$			TXEN at 2 V, See Figure 3	1	5	ns

receiver

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high level output	$\overline{\text{RXI}}$, RXI	RXO	V_{IC} = 1 V to 4.2 V, See Figure 10		15	ns
t_{PHL}	Propagation delay time, high-to-low level output	$\overline{\text{RXI}}$, RXI	RXO	V_{IC} = 1 V to 4.2 V, See Figure 10		15	ns
t_{PLH}	Start-up delay time, low-to-high level output	$\overline{\text{RXI}}$, RXI	RXEN	V_{IC} = 1 V to 4.2 V, V_{ID} = –500 mV, See Figure 12		55	ns
t_{PHL}	Shutdown delay time, high-to-low level output	$\overline{\text{RXI}}$, RXI	RXEN	V_{IC} = 1 V to 4.2 V, V_{ID} = 500 mV, See Figure 12	142	181	ns
t_{sk}	Receiver caused signal skew ($t_{PLH} - t_{PHL}$)	$\overline{\text{RXI}}$, RXI	RXO	V_{IC} = 1 V to 4.2 V, V_{ID} = 500 mV, See Figure 10		±3	ns
t_w	Pulse duration at $\overline{\text{RXI}}$ and RXI (to not activate squelch)			V_{IC} = 1 V to 4.2 V, V_{ID} = –175 mV, See Figure 11	25		ns
t_w	Pulse duration at $\overline{\text{RXI}}$ and RXI (to activate squelch)			V_{IC} = 1 V to 4.2 V, V_{ID} = –275 mV, See Figure 11		50	ns
t_{r1}	Rise time, RXO			V_{IC} = 1 V to 4.2 V, V_{ID} = ±500 mV, See Figure 10	1	8	ns
t_{r2}	Rise time, RXEN			V_{IC} = 1 V to 4.2 V, V_{ID} = ±500 mV, See Figure 12	1	8	ns
t_{f1}	Fall time, RXO			V_{IC} = 1 V to 4.2 V, V_{ID} = ±500 mV, See Figure 10	1	8	ns
t_{f2}	Fall time, RXEN			V_{IC} = 2.5 V, V_{ID} = ±500 V, See Figure 12	1	8	ns
t_v	RXO valid after RXEN high			See Figure 10	–10	15	ns

switching characteristics over recommended ranges of supply voltage and operating free-air temperature

loop

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high level output	TXI	RXO	LOOP at 0.8 V, TXEN at 2 V, See Figure 13		30	ns
t_{PHL}	Propagation delay time, high-to-low level output	TXI	RXO	LOOP at 0.8 V, TXEN at 2 V, See Figure 13		30	ns
t_{PLH}	Propagation delay time, low-to-high level output	TXEN	RXEN	LOOP at 0.8 V, See Figure 14		50	ns
t_{PHL}	Propagation delay time, high-to-low level output	TXEN	RXEN	LOOP at 0.8 V, See Figure 14		50	ns

PARAMETER MEASUREMENT INFORMATION

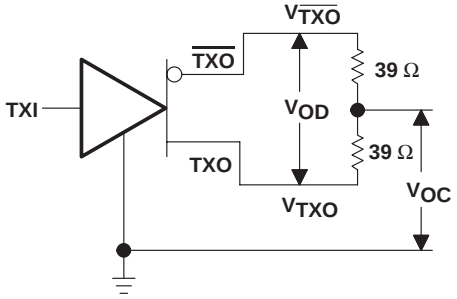


Figure 1. Driver Test Circuit

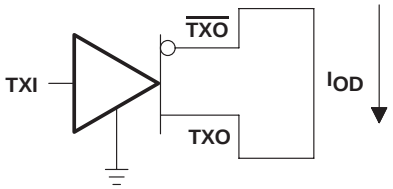
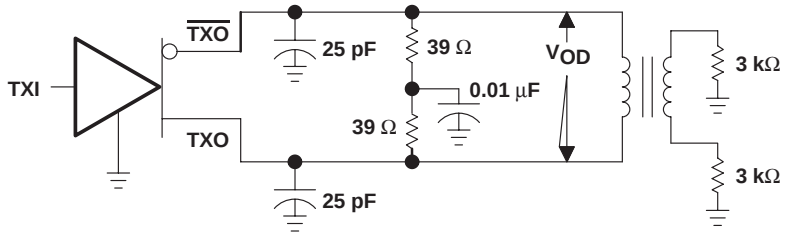
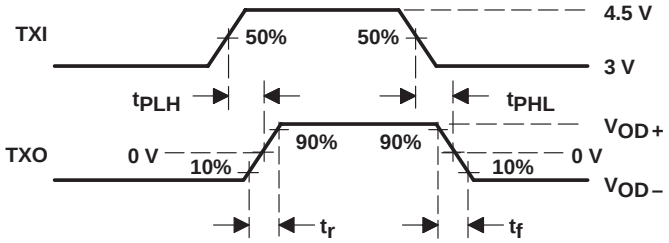


Figure 2. Driver Test Circuit

PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



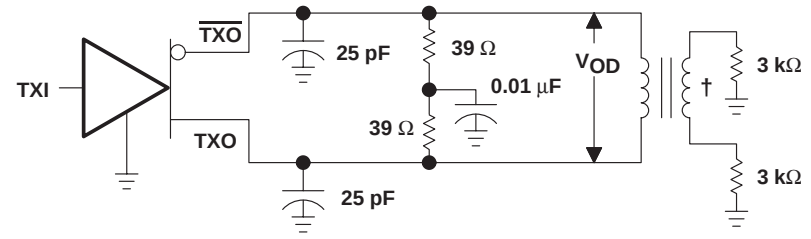
VOLTAGE WAVEFORMS

TRANSFORMER SPECIFICATIONS

Turns Ratio	1:1
Magnetizing Inductance	26 to 30 μH
Winding Resistance	0.6 Ω Max
Rise Time 10% to 90%	5 ns Max
Interwinding Capacitance	25 pF
Leakage Inductance	0.25 μH Max
Inductive Q	1250 Min

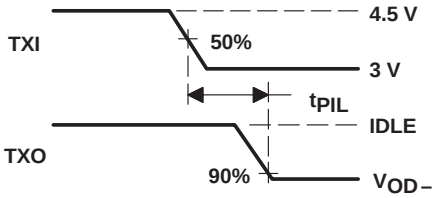
Figure 3. Test Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



† See Figure 3

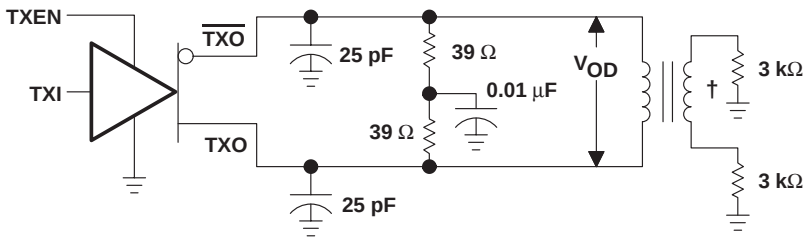
TEST CIRCUIT



VOLTAGE WAVEFORMS

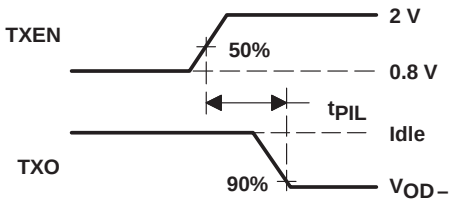
NOTE: Input $t_r \leq 5$ ns; $t_f \leq 5$ ns

Figure 4. Test Circuit and Voltage Waveforms



† See Figure 3

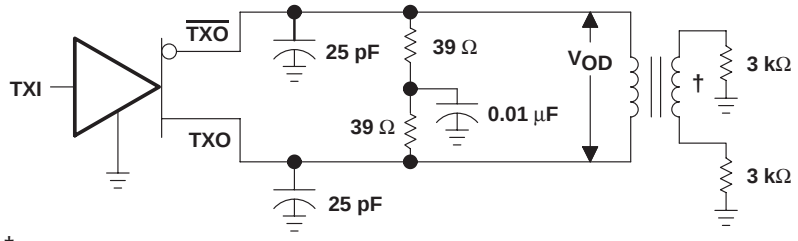
TEST CIRCUIT



VOLTAGE WAVEFORMS

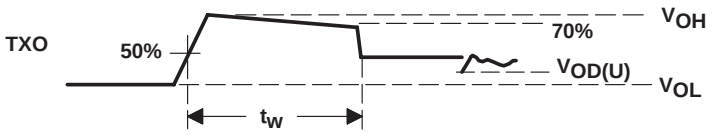
Figure 5. Test Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



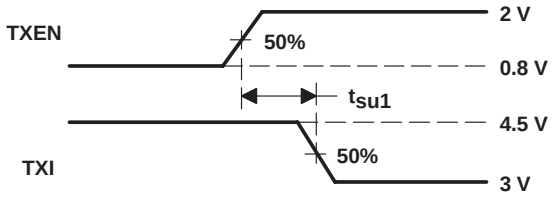
† See Figure 3

TEST CIRCUIT



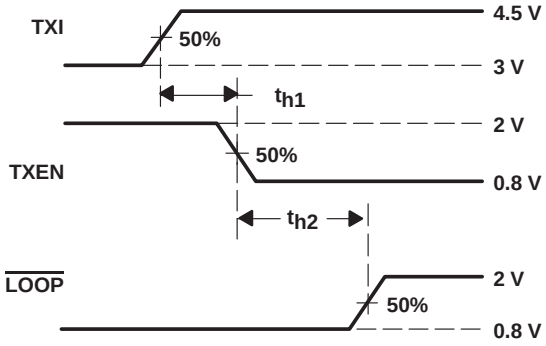
VOLTAGE WAVEFORMS

Figure 6. Test Circuit and Voltage Waveforms



NOTE: Input $t_r \le 5$ ns; $t_f \le 5$ ns

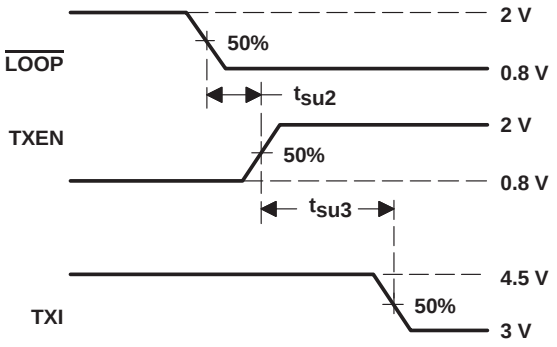
Figure 7



NOTE: Input $t_r \le 5$ ns; $t_f \le 5$ ns

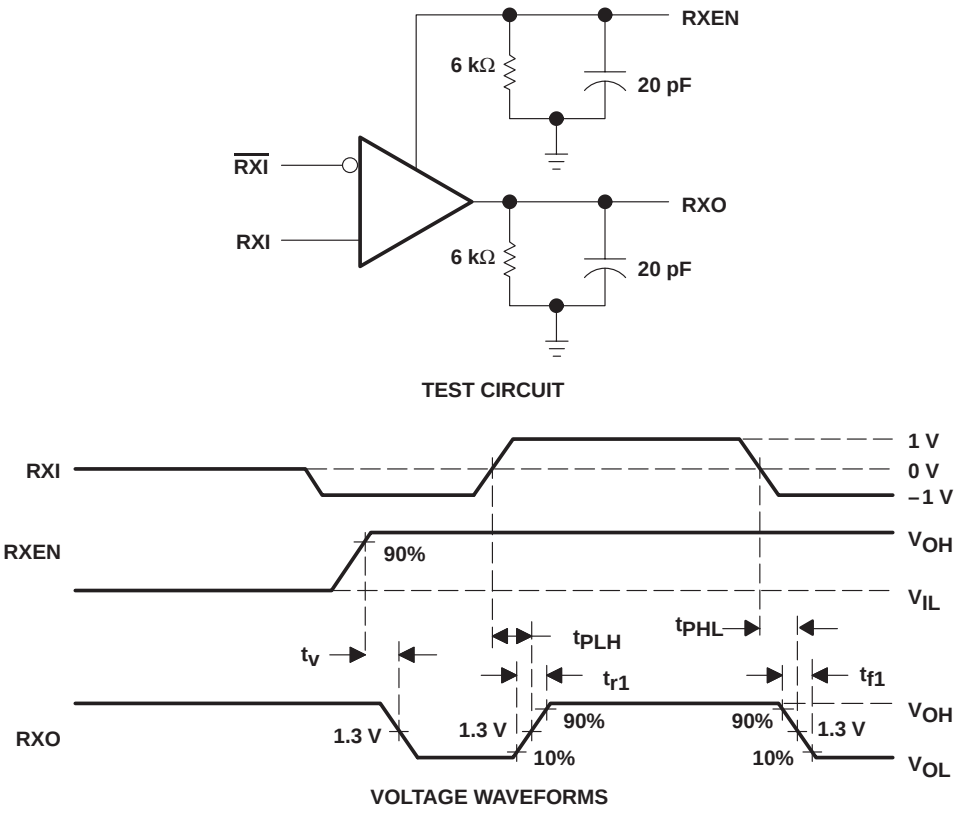
Figure 8

PARAMETER MEASUREMENT INFORMATION



NOTE: Input $t_r \leq 5$ ns; $t_f \leq 5$ ns

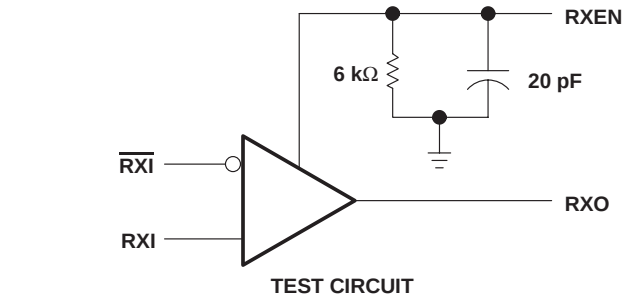
Figure 9



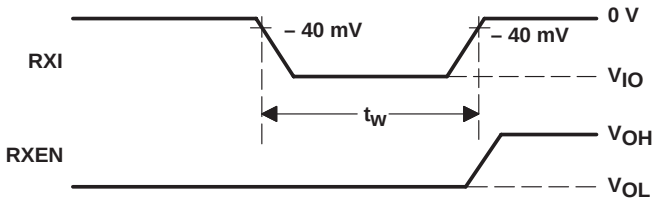
NOTE: Input $t_r \leq 5$ ns; $t_f \leq 5$ ns

Figure 10. Test Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



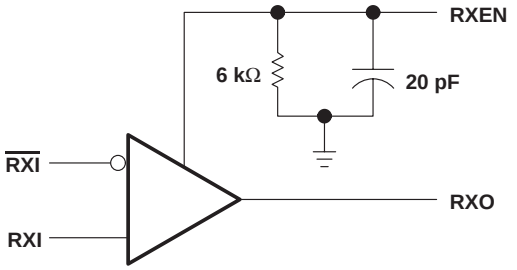
TEST CIRCUIT



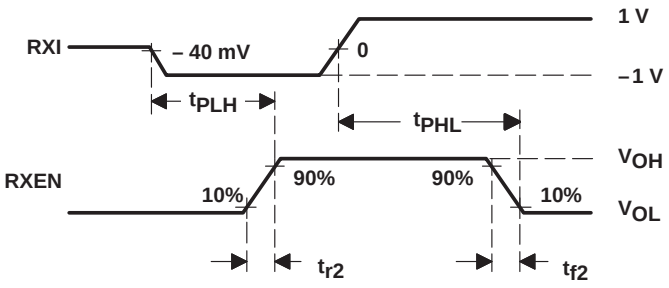
VOLTAGE WAVEFORMS

NOTE: Input $t_r \leq 5$ ns; $t_f \leq 5$ ns

Figure 11. Test Circuit and Voltage Waveforms



TEST CIRCUIT

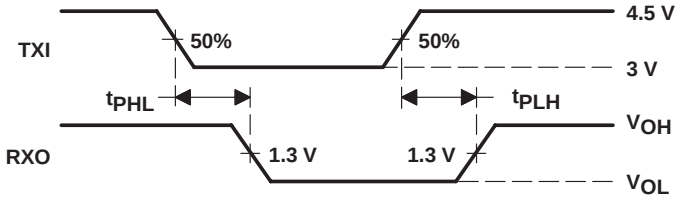


VOLTAGE WAVEFORMS

NOTE: Input $t_r \leq 5$ ns; $t_f \leq 5$ ns

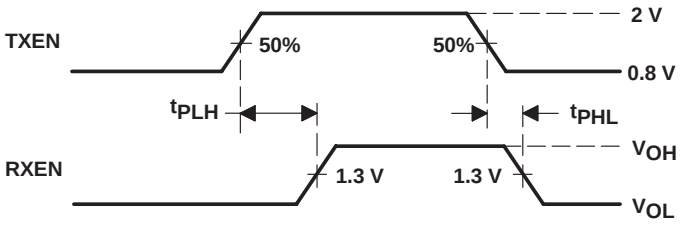
Figure 12. Test Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



NOTE: Input $t_r \leq 5$ ns; $t_f \leq 5$ ns

Figure 13



NOTE: Input $t_r \leq 5$ ns; $t_f \leq 5$ ns

Figure 14

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